		Aces P/N: 50925 series							
Т	ITLE: USB 3.0 A TYPE								
REL	EASE DATE: 2019.12.05 REVISION: V	ECN No: ECN-1912124	PAGE: 4 OF 9						
2	SCOPE This specification covers performan	ce, tests and quality requirements fo	or USB 3.0						
3	CONNECTOR. APPLICABLE DOCUMENTS EIA-364 : ELECTRONICS INDUSTRIES ASSO	CIATION							
4	REQUIREMENTS								
	4.1 Design and Construction								
	<ul> <li>4.1.1 Product shall be of design, construction and physical dimensions specified on applicable product drawing.</li> <li>4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.</li> </ul>								
	4.2 Materials and Finish								
	<ul> <li>4.2.1 Contact: High performance Finish: (a) Contact Area: G (b) Under plate: Nic (c) Solder area: Tin</li> <li>4.2.2 Housing: Thermoplastic or</li> </ul>	copper alloy (Phosphor Bronze & Brass old plated based on order information kel-plated all over plated Thermoplastic High Temp.	s)						
	4.2.3 Shell: Stainless steel								
	4.3 Ratings	-)							
	4.3.1 Voltage: 30 Volts AC (per p 4.3.2 Current: 1.8 A FOR PIN 1 A 0.25A FOR ALL TH 4.3.3 Operating Temperature : -55	n) ND PIN 4 E OTHER CONTACTS ℃ to +85℃							
		Page 4 2010/10/	/31 TR-FM-730151						

 Aces P/N:
 50925 series

 TITLE:
 USB 3.0 A TYPE

 RELEASE DATE:
 2019.12.05

 REVISION: V
 ECN No:

 ECN No:
 ECN-1912124

## 5 Performance

## 5.1. Test Requirements and Procedures Summary

ltem	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification	Visual, dimensional and functional per applicable quality inspection
	ELECTRICAL	
ltem	Requirement	Standard
Low Level Contact Resistance	30 m $\Omega$ (Max) initial for VBUS and GND contacts. 50 m $\Omega$ (Max) initial for all other contacts. $\triangle$ R 10 m $\Omega$ Max. after environmental stresses	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	100 M Ω Min.	Unmated and mated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric withstanding voltage	No discharge, flashover or breakdown. Current leakage: 1 mA max.	100 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated and mated connectors. (EIA-364-20)
Temperature rise	30℃ Max. Change allowed	A current of 1.8 A shall be applied to VBUS pin and its corresponding GND pin. Additionally, a minimum current of 0.25 A shall be applied to all tile other contacts. when measured at an ambient temperature of 25 °C. (EIA-364-70 METHOD 2)
Differential Impedance	$90\Omega + -15\Omega$ Reefer to High Frequency Graphic Figure 1	Mated connector 50 ps (20%-80%) Risetime.
	MECHANICAL	
ltem	Requirement	Standard
Durability	5000 cycles.	The durability test shall be done at a maximum rate of 200 cycles per hour and no physical damage to any part of the connector and cable assembly shall occur. (EIA-364-09)
Insertion / Extraction Force	tion / Extraction Force Insertion Force: 35 N Max. Extraction Force: 10 N Min. Initial 8 N Min. Final (EIA-364- Deperation 12.5 ± 3 r Measure mate/unm (EIA-364- 00 N Min. Initial 8 N Min. Final	

	Aces P/N: 50925 Se	ries
LE: USB 3.0 A TYPE		
ASE DATE: 2019.12.05 REVI	SION: V ECN No: E	CN-1912124 PAGE: 6 OF 9
Vibration	1 µs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
	ENVIRONMENTA	Ĺ
Item	Requirement	Standard
Resistance to <b>Reflow</b> Soldering Heat	See Product Qualification and Test Sequence Group 8	Pre Heat : 150°C~180°C, 60~120sec. Heat : 230°C Min., 40sec Min. Peak Temp. : 260°C Max,
Thermal Shock	See Product Qualification and Test Sequence Group 4	(EIA-364-56) Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, Test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 105°C for 96 hours. (EIA-364-17, Test condition A)
Salt Spray	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) NiPd 30u" for 96 hours. (III) Au 30u" for 96 hours (IV) Au 15u" for 48 hours (EIA-364-26)
Solder ability	Solder able area shall have minimum of 95% solder coverage.	And then into solder bath, Temperature at $245 \pm 5^{\circ}$ C, for 5 sec. (EIA-364-52)



		Aces F	P/N: 5	0925	ser	ies						
1	ILE: USB 3.0 A TYPE											
E	ASE DATE: 2019.12.05 REVISION: V			ECN	No: EC	N-191	2124		PAGE: 8 OF 9			
	PRODUCT QUALIFICATION AND TEST SEQUENCE											
			Test Group									
	Test or Examination	1	2	3	4	5	6	7	8	9	10	
			Test Sequence									
	Examination of Product				1 • 7	1、6	1、4		1			
	Low Level Contact Resistance		1、5	1、3	2、10	2 \ 9	2、5		3			
	Insulation Resistance				3、9	3、8						
ĺ	Dielectric Withstanding Voltage				4 • 8	4 \ 7						
	Temperature rise	1										
	Insertion / Extraction Force		2、4									
	Durability		3									
	Vibration			2								
	Thermal Shock				5							
	Humidity				6							
	Temperature life					5						
	Salt Spray						3					
	Solder ability							1				
	Resistance to Soldering Heat								2			
	Sample Size	2	4	4	4	4	4	2	4			

